

Automotive and Industrial Qualified Bluetooth Low Energy Wireless MCUs

# Kinetis<sup>®</sup> KW36/35/34 Bluetooth 5 Wireless MCUs with Integrated CAN/ CAN FD and LIN Bus

Kinetis KW36/35/34 wireless MCUs feature AEC-Q100 Grade 2 or industrial qualification and the latest Bluetooth technology for superior durability and performance in automotive, industrial and healthcare applications.

## **OVERVIEW**

Based on the Arm<sup>®</sup> Cortex<sup>®</sup>-M0+ core, the Kinetis KW36/35/34 wireless MCUs integrates a Bluetooth Low Energy version 5 and Generic FSK radio. The radio supports up to 8 simultaneous secure connections in any master/ slave combination allowing multiple authorized users to communicate with the device.

Additionally, the Kinetis KW36 MCU exclusively integrates FlexCAN, enabling seamless integration into an automobile's in-vehicle or industrial CAN communication network. The FlexCAN module can support CAN's flexible data rate (CAN FD) for increased bandwidth and lower latency.

## TARGET APPLICATIONS

## Automotive

- Car access
- Car sharing
- Passive entry/passive start (PEPS) systems
- Tire pressure measurement sensors (TPMS) systems
- Wireless onboard diagnostic functions

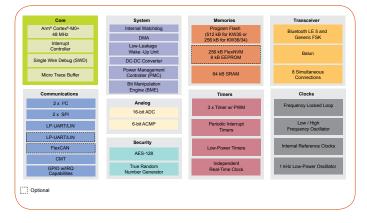
## Industrial

- Building control and monitoring
- ▶ Fire and safety

#### Healthcare

- Home and institutional healthcare
- Patient monitoring

## KINETIS KW36/35/34 WIRELESS MCU FAMILY BLOCK DIAGRAM





## **FEATURES**

All MCUs in this family contain an integrated buck DC-DC converter that supports operating voltages from 2.1-3.6 V and significantly reduces the peak current in receive and transmit modes to extend the useful life of a battery. At the same time, this family delivers an excellent link budget that ensures the longest range of communication and a high immunity to interference.

This family has up to 512 kB Flash memory with ECC and 64 kB SRAM allowing plenty of space for protocol stacks, application profiles and custom user firmware. In addition, the radio can provide the necessary information in order to accurately estimate the distance (ranging) of a remote Bluetooth LE device to determine its position.

For automotive applications, Kinetis KW36A/35A/34A devices are AEC-Q100 Grade 2 qualified and are provided in 6 mm x 6 mm 40HVQFN and 7 mm x 7 mm 48HVQFN packages with "wettable" flank package technology enabling optical inspection of soldering, reducing cost and increasing reliability.

## **ENABLEMENT**

Take advantage of the robust enablement package that includes the fully certified Bluetooth LE 5 host and controller stacks, Bluetooth LE application profiles in source, generic FSK software protocol, RTOS, development tools and IDEs. These tools are designed for use with Kinetis KW36/35/34 MCUs and are fully integrated in the MCUXpresso software and tools suite.

#### **KINETIS KW36/35/34 WIRELESS MCU FAMILYFEATURES AND BENEFITS**

Features	Benefits		
Features			
Bluetooth <sup>®</sup> LE 5 with 8 simultaneous connections	Supports simultaneous secure connections in any master/slave combination		
Connections	Keeps all connections alive for continuous monitoring		
6.3 mA typical Rx and 5.7 mA Tx current with DC-DC activated	Significantly reduces power consumption and extends battery life		
-95 dBm typical BLE sensitivity	High link budget improves range and lowers cost by reducing		
-99 dBm typical generic FSK (at 250 kbit/s)	the need for external power amplifiers		
sensitivity	Integrated balun enables smaller design and reduces system		
+5 dBm maximum output power	costs		
Excellent selectivity and blocking	Significantly improves operation in harsh 2.4 GHz environments		
48 MHz Arm <sup>®</sup> Cortex <sup>®</sup> -M0+ core			
Up to 512 kB flash memory with ECC	High-performance, low-power core with adequate memory to run Bluetooth LE, generic FSK protocol stacks and application		
64 kB SRAM	The bidecooth EE, generic 13K protocol stacks and application		
AES-128 accelerator	Fast encryption/decryption utilizing hardware security		
True random number generator	algorithms for network commissioning and transmissions of supported protocols		
Buck DC-DC converter working from 2.1 V to 3.6 V	Supports a wide range of batteries from coin-cell to Lithium-ion		
16-bit analog-to-digital converter (ADC)	Supports high-performance on-chip analog at the MCU level		
6-bit high-speed analog comparator (CMP)	for sensor aggregation and other sophisticated applications		
CAN/CAN FD and LIN Bus	Enables easy integration into automotive in-vehicle and industrial networks		
7 x 7 mm 48LQFN	Smaller size and low component count reduces cost. The		
6 x 6 mm "wettable" flanks 40HVQFN	wettable flanks package technology enable optical inspection		
7 x 7 mm "wettable" flanks 48HVQFN	of the soldering, reducing cost and increasing reliability.		

#### PART NUMBERS

Part Number	Qualification	CAN FD	2nd UART with LIN	8kB EEPROM	Package
MKW36A512VFP4	Automotive	Y	Y	Y	6 x 6 40-pin
MKW36Z512VFP4	Industrial	Y	Y	Y	Wettable
MKW35A512VFP4	Automotive	N	N	N	HVQFN
MKW36A512VHT4 MKW36Z512VHT4 MKW35Z512VHT4	Automotive Industrial Industrial	Y Y N	Y Y N	Y Y N	7X7 48-pin Laminate QFN
MKW36A512VFT4	Automotive	Y	Y	Y	7 x 7 48-pin
MKW35A512VFT4	Automotive	N	N	N	Wettable
MKW34A512VFT4	Automotive	N	N	Y	HVQFN

#### **DEVELOPMENT TOOLS**

Board Name	Description
FRDM-KW36	Freedom development board for Kinetis KW36/35 MCUs with 2.4 GHz Bluetooth® LE and generic FSK wireless connectivity and CAN/LIN connectivity solutions
USB-KW41Z	USB dongle for sniffer operations for Kinetis wireless MCUs with 2.4 GHz Bluetooth LE and generic FSK

#### www.nxp.com/Wireless/KinetisKW36

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